INFORMATION NOTE



N° 096/18

Dear Customer,

With this INFINEON Technologies Information Note we would like to inform you about the following

Additional Source for Ni-electroplating of Copper Baseplates for IHM A, IHM B and PrimePACK™ 2/3

Infineon Technologies AG
Postal Address Headquarters: Am Campeon 1-15, D-85579 Neubiberg, Phone +49 (0)89 234-0
Chairman of the Supervisory Board: Dr. Eckart Sünner
Management Board: Dr. Reinhard Ploss (CEO), Dominik Asam, Dr. Helmut Gassel, Jochen Hanebeck
Registered Office: Neubiberg Commercial Register
Amtsgericht München HRB 126492

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INFORMATION NOTE



N° 096/18

Additional Source for Ni-Electroplating of Copper Baseplates for IHM A, IHM B and PrimePACK™ 2/3

Products affected:
 Please refer to attached affected product list 1_cip09618.xlsx

Detailed Change Information:

Subject: Additional source for Ni-electroplating of baseplate for IHMA/IHMB and

PrimePACK™ 2/3

Reason: Additional source for Ni-electroplating of baseplate to secure

long term delivery availability.

Description: Old New

Single Source for Base plate with Ni coating

Dual Source for Base plate with Ni coating

Product Identification:
 Date Code

Impact of Change:
No change of used materials.

The specifications of the formerly mentioned modules remain unchanged according to JEDEC Standard JESD46C: form, fit, function and reliability.

Attachments:
 Affected product list 1_cip09618.xlsx

Intended start of From November 2018 onwards delivery:

If you have any questions, please do not hesitate to contact your local Sales office.

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